1. Scope of Application

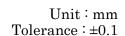
These specifications are applied to the chip type LED lamp, model CL-824-MU1D-T.

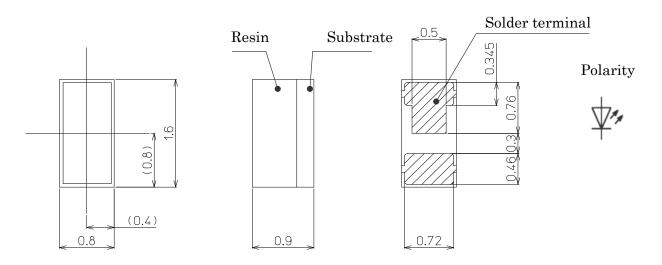
2. Part code

$CL - \underline{824} - \underline{MU1} \underline{D} - \underline{T}$
Series 824 : White LED for general lighting.
Special specifications M : General Color Rendering Index Typ. 85 Type.
Watt class U1 : Under 1 watt package.
Lighting color D : Correlated Color Temperature 6300(K)
Shipping mode Non-coded : Bulk T : Taping (standard)

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3. Outline drawing





4. Performance

(1) Absolute Maximum Rating

Parameter	Symbol	Raiting Value	Unit	
Power Dissipation	P _D	105	mW	
Forward Current	$I_{\rm F}$	30	mA	
Forward Pulse Current	I_{FP}	100	mA	*1
Reverse Voltage	V _R	5	V	
Operating Temperature	T _{OP}	$-30 \sim +85$	С	
Storage Temperature	T_{ST}	$-40 \sim +100$	С	
Junction Temperature	Tj _{Max}	120	С	*2

*1 Forward Current : Duty<=1/10 , Pulse Width<=10msec *2 D.C. Current : Tj = Tc + Rj-c × P_D

 $\label{eq:pulse} \begin{array}{l} Pulse \ Current: Tj = Tc + Rj \cdot c \times Pw(Power \ Dissipation \ / \ One \ Pulse) \times Duty \\ *Ts: Solder \ terminal(Anode) temperature \end{array}$

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Ref.CE-P907 10/10					

(2) Electro-optical Characteristics Ts=25						Ts=25C
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V _F	I _F =20mA	2.8	3.2	3.5	V
Reverse Current	IR	V _R =5V	-	-	100	μA
Thermal Resistance	$Rj-s^{*2}$	Junction-solder	-	175	-	C/W
Luminous Intensity ^{*1}	Iv	I _F =20mA	1240	1730	-	mcd
Luminous Flux	$\phi_{\rm V}$	I _F =20mA	-	(4.8)	-	lm
General Color Rendering Index	Ra	I _F =20mA	80	85	-	-

*1 In accordance with NIST standard

*2 Thermal Resistance : Junction - Solder terminal (Anode)

Ranking (Condition : IF=20mA , Ts=25C)

Parameter	Symbol	Rank	Min.	Max.	Unit
		Q	2.8	3.0	
Forward Voltage	V_{F}	R	3.0	3.2	V
		S	3.2	3.5	
		В	1240	1404	
Luminous Intensity	Iv	С	1404	1900	mcd
		D	1900	2571	

Chromaticity coordinates (Condition : I_F =20mA , T_S =25C)

Color Rank	X	у	Color Rank	Х	у
	0.317	0.327		0.319	0.311
MDe	0.317	0.331	MDe	0.317	0.327
MDc	0.331	0.353	MDe	0.331	0.340
	0.331	0.340		0.331	0.322

Color Rank	X	у
	0.310	0.302
MDd	0.307	0.316
MDu	0.317	0.331
	0.319	0.311

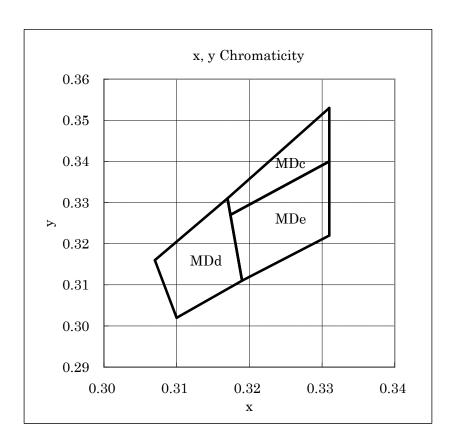
*1 The tolerance of measurement at our tester is VF±3% , $\phi v\pm 10\%$, Chromaticity(x,y)±0.01.

 $\ast 2$ For handling , please apply CMOS LSI or equivalent any electrostatic effect.

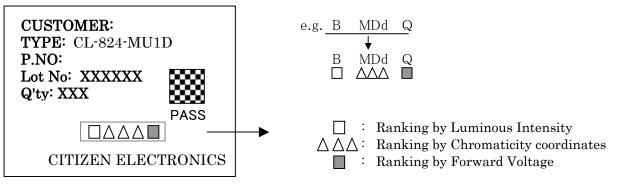
Measurement Conditions

- 1) Chip is mounted on board(size 100mm×40mm)
- 2) Board material is FR-4, covered with green color resist and thickness of copper is $18 \mu m.$

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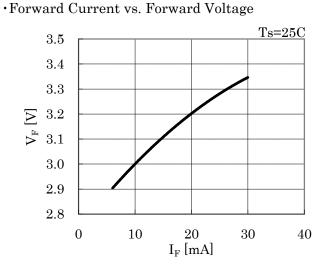


Rank information

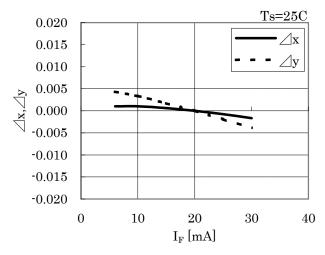


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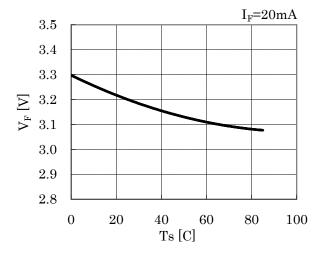
5. Characteristics

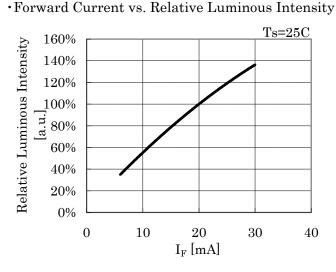


·Forward Current vs. Chromaticity Coordinate

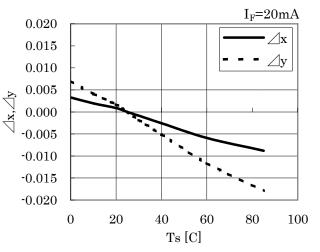


·Solder Temperature vs. Forward Voltage

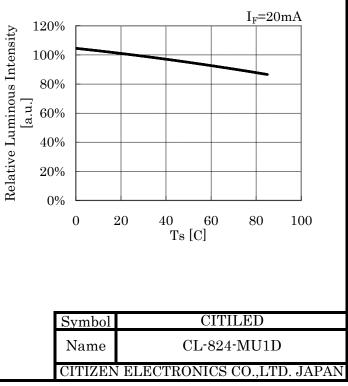




 $\cdot Solder$ Temperature vs. Chromaticity Coordinate

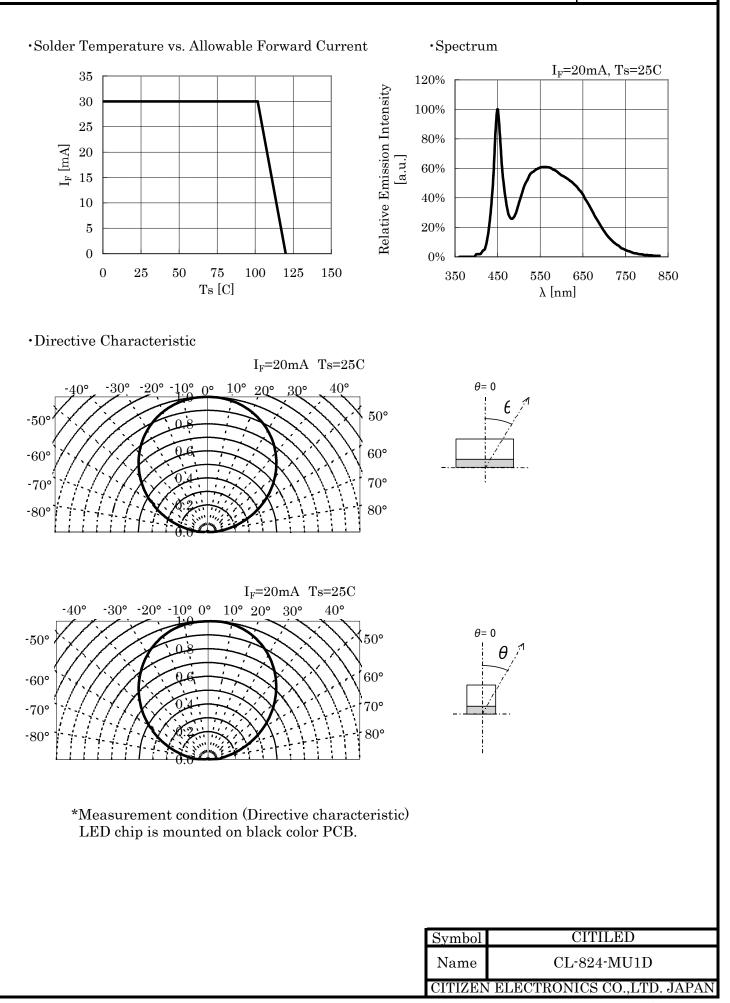


·Solder Temperature vs. Relative Luminous Intensity



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6. Reliability

(1) Details of the tests

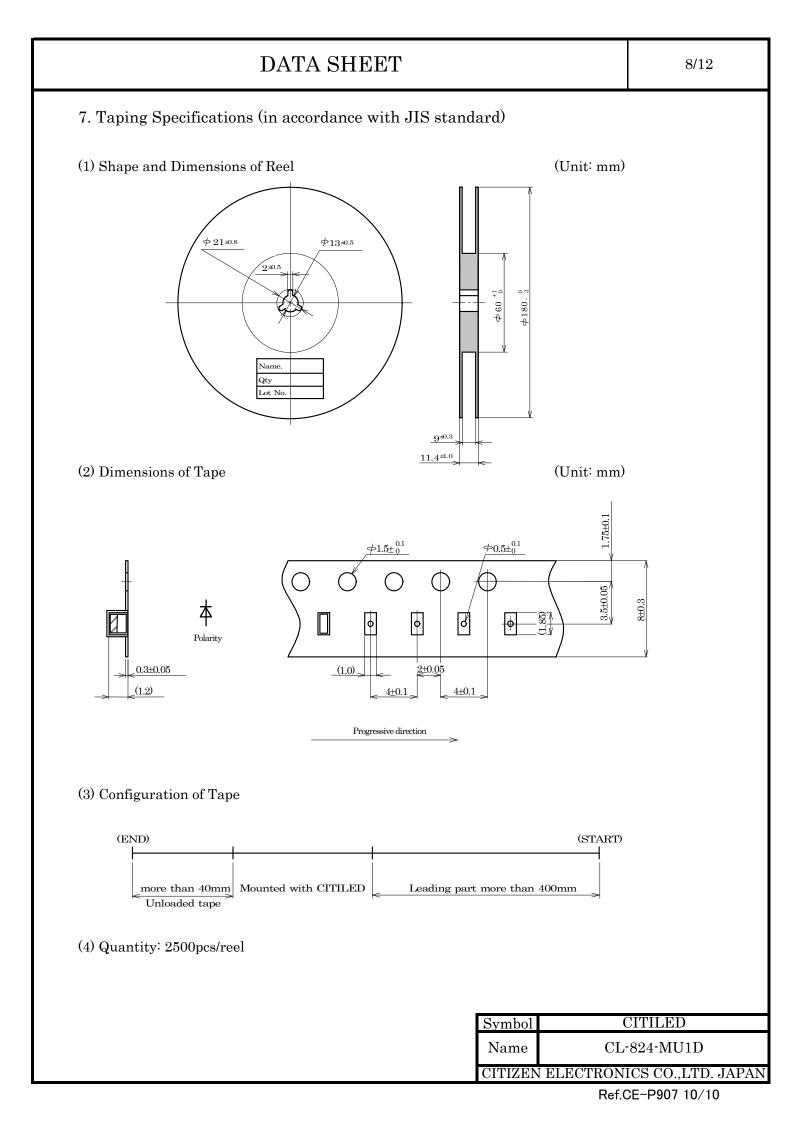
Test Item	Test Condition
	Ta=-30C, I_F =20mA , 1000 hours(with Al-fin)
Continuous Operation Test	Ta=25C, I_F =20mA , 1000 hours(with Al-fin)
	Ta=85C, I_F =20mA , 1000 hours(with Al-fin)
Low Temperature Storage Test	Ta=-40C , 1000 hours
High Temperature Storage Test	Ta=100C, 1000 hours
Moisture-proof Test	Ta=60C, 90%RH, 1000 hours
Thermal Shock Test	Ta=-40C 30minutes~100C 30minuets, 100cycle
Solder Heat Resistance Test	Recommended temperature profile (reflow soldering) $ imes2$,
bolder freat Resistance fest	$(2nd \ test \ must \ be \ started \ after \ the \ samples \ are \ \ stabilized \ thermally.)$

(2) Judgment Criteria of Failure for Reliability Test Ta=				
Measuring Item	Symbol	Measuring Condition	Judgment Criteria for Failure	
Forward Voltage	$V_{\rm F}$	I _F =20mA	> U×1.2	
Reverse Current	I_{R}	$V_R=5V$	> U×2	
Luminous Intensity	I _V	I _F =20mA	< S×0.7	

U defines the upper limit of the specified characteristics. S defines the initial value.

* Measurement shall be taken between 2 hours and 24 hours, and the test pieces should be returned to the normal ambient conditions after the completion of each test.

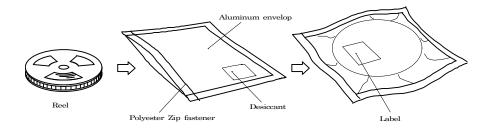
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8. Packing Specifications

8-1. Moisture-proof Packing

To prevent moisture absorption during transportation and storage, reels are packed in aluminum envelopes which contain a desiccant with a humidity indicator.



8-2. Storage

To prevent moisture absorption, it is strongly recommended that reels (in bulk or taped) should be stored in the dry box (or the desiccator) with a desiccant as the appropriate storage place. If not, the following is recommended.

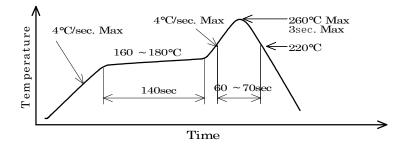
Temperature :5~30CHumidity :60%RH max.

The devices should be mounted as soon as possible after unpacking. If you store the unpacked reels, please store them in the dry box or seal them into the envelop again. MSL 1 (IPC/JEDEC J-STD-020C)

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9. Precautions

- 9-1. Soldering
- (1) Lead free soldering
 - Following soldering paste is recommended Melting temperature : 216 ~ 220C. Composition : Sn 3.5Ag 0.75Cu
 - 2) The temperature profile at the top surface of the parts is recommended as shown below.
 - 3) It is requested that products should be handled after their temperature has dropped down to the normal room temperature



- 9-2. Washing
- (1) When washing after soldering is needed, following conditions are requested.
 - a) Washing solvent: Pure Water
- b) Temperature, time: 50C or less × 30 seconds max.
- c) Ultrasonic washing: 300W or less

9-3. Other directions

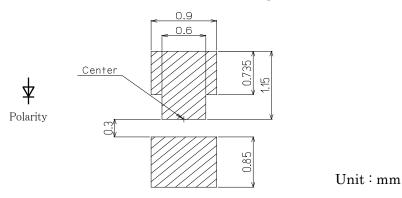
- (1) It is requested to avoid any stress added to the resin portion while it is heated.
- (2) It is requested to avoid any friction by sharp metal nail etc. to the resin portion.

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10. Designing precautions

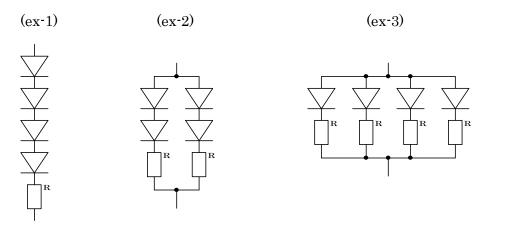
- 1. The current limiting resistor should be placed in the circuit so that is driven within its rating. Also avoid reverse voltage (over-current) applied instantaneously when ON or OFF.
- 2. When pulse driving current is applied, average current consumption should be within the rating. Also avoid reverse voltage applied when put off.
- 3. Recommended soldering pattern

< For reflow soldering >



The above dimensions are not the one which guarantee the performance of mount ability. The use of the above pattern is recommended to use after deep study at your site.

- 4. When assembling the circuit board into the finished products, care must be taken to avoid the component parts from touching other parts.
- 5. When using multiple LEDs, it is required to connect a current limiting resistor on each path which the current flows to the LEDs.



6. Other

This product complies with RoHS directives.

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